

### SURFACE MOUNT ZENER DIODE

### **Features**

- Planar Die Construction
- Small Surface Mount Package
- Ideally Suited for Automated Assembly Processes
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- PPAP Capable (Note 4)

## **Mechanical Data**

- Case: SOD323
- Case Material: Molded Plastic.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208 (e3)
- Lead-Free Plating (Matte Tin Finish Annealed over Alloy 42 Leadframe). Polarity: Cathode Band
- Weight: 0.004 grams (Approximate)



Top View

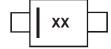
## Ordering Information (Note 5)

Part Number	Compliance	Case	Packaging	
MMSZ5232BSQ-7-F	Automotive	SOD-323	3000/Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to https://www.diodes.com/quality/.
- 5. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**



XX = Product Type Marking Code (See Electrical Characteristics Table)

Date Code Key

Year	2018	2019	2020	202	1 2	2022		2025	202	6	2027	2028
Code	F	G	Н	-		J		М	N		0	Р
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



# **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Forward Voltage (Note 6)	@ $I_F = 10mA$	$V_{F}$	0.9	V

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 7)	$P_{D}$	200	mW
Thermal Resistance, Junction to Ambient Air (Note 7)	$R_{\Theta JA}$	625	°C/W
Operating and Storage Temperature Range	$T_{J_i}T_{STG}$	-65 to +150	°C

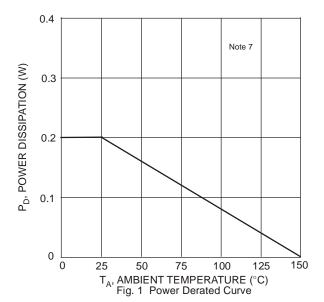
# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

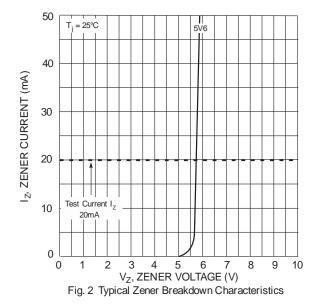
_		Zener Voltage Range (Note 8)			Test Current	Maximum Zener Impedance (Note 9)		Maximum Reverse Leakage Current (Note 8)		Typical Capacitance
Type Number	Marking Code	Vz @ IzT		I <sub>ZT</sub>	Z <sub>ZT</sub> @ I <sub>ZT</sub>	Z <sub>ZK</sub> @ I <sub>ZK</sub> = 0.25mA	I <sub>R</sub>	@ V <sub>R</sub>	C @ VR = 0 f = 1 MHz	
		Nom (V)	Min (V)	Max (V)	mA		Ω	μA	V	pF
MMSZ5232BSQ	E2	5.6	5.32	5.88	20	11	1600	5.0	3.0	85

Notes:

- 6. Short duration pulse test used to minimize self-heating effect.
- 7. Part mounted on FR-4 PCB with recommended pad layout, which can be found at https://www.diodes.com/package-outlines.html.
  8. Short duration pulse test used to minimize self-heating effect.
- 9. f = 1KHz.





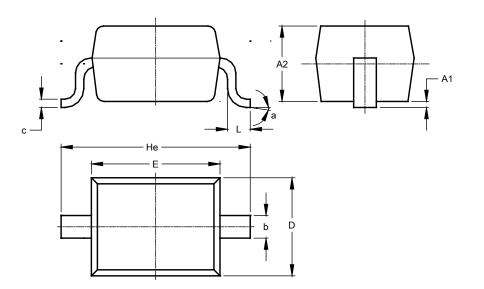




## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### **SOD323**

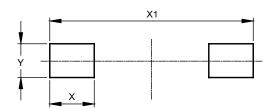


SOD323  Dim Min Max Typ								
Dim	Min	Min Max						
A1		0.10	0.05					
A2	1.00	1.10	1.05					
b	0.25	0.35	0.30					
С	0.10	0.15	0.11					
D	1.20	1.40	1.30					
Е	1.60	1.80	1.70					
He	2.30	2.70	2.50					
L	0.20	0.40	0.30					
а	00	8°						
All Dimensions in mm								

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### **SOD323**



Dimensions	Value (in mm)
Х	0.590
X1	2.700
Υ	0.450



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